



Power MOSFETS

DATASHEET

LM45013NAM8A

N-Channel
Enhancement Mode MOSFET

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Quality Management Systems
ISO 9001:2015 Certificate

N-Channel Enhancement Mode MOSFET

Pin Description

LFPACK56		Symbol	Symbol	N-Channel	Unit
Top view	Bottom view			V _{DSS}	V
				R _{DSON-Max}	mΩ
				ID	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested
- Moisture Sensitivity Level MSL1

Product Summary

Symbol	N-Channel	Unit
V _{DSS}	45	V
R _{DSON-Max}	0.99	mΩ
ID	269	A

Applications

- DC-to-DC converters
- Switch Mode Power Supply
- Brushless DC motor control

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM45013NAM8A	LFPACK56	Tape & Reel	4000 / Tape & Reel	45013 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note : = Lot Code

Absolute Maximum Ratings (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V _{DSS}	Drain-Source Voltage	45	V
V _{GSS}	Gate-Source Voltage	±20	
T _J	Maximum Junction Temperature	175	°C
T _{STG}	Storage Temperature Range	-55 to 175	°C
I _S	Diode Continuous Forward Current	T _c =25°C 95	A
I _{SP}	Diode Pulse Current	T _c =25°C 400 ^①	A
I _{DM}	Pulse Drain Current Tested	T _c =25°C 800 ^①	A
I _D	Continuous Drain Current	T _c =25°C 269 T _c =100°C 135	A
P _D	Maximum Power Dissipation	T _c =25°C 125 T _c =100°C 62.5	W
I _D	Continuous Drain Current	T _A =25°C 40 T _A =70°C 33	A
P _D	Maximum Power Dissipation	T _A =25°C 3.3 T _A =70°C 2.3	W
I _{AS^②}	Avalanche Current, Single pulse	L=0.1mH 64 L=0.5mH 34	A
E _{AS^②}	Avalanche Energy, Single pulse	L=0.1mH 204 L=0.5mH 290	mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit
R _{θJC}	Thermal Resistance-Junction to Case	Steady State 1.2	°C/W
R _{θJA^③}	Thermal Resistance-Junction to Ambient	Steady State 45	°C/W

Note ① : Max. current is limited by junction temperature.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 175C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

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N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{DS}}=250\mu\text{A}$	45	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=36\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{DS}}=250\mu\text{A}$	1.3	2	2.5	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{DS}}=20\text{A}$	-	0.7	0.99	mΩ
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	1.5	2.0	
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	48	-	S
Dynamic Characteristics ^⑤						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, Freq.=1MHz	-	0.9	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=20\text{V}$, Freq.=1MHz	-	5830	-	pF
C_{oss}	Output Capacitance		-	1439	-	
C_{rss}	Reverse Transfer Capacitance		-	80	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=22.5\text{V}$, $I_{\text{D}}=1\text{A}$, $R_{\text{GEN}}=1\Omega$	-	15.3	-	nS
t_{r}	Turn-on Rise Time		-	12.5	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	50.0	-	
t_{f}	Turn-off Fall Time		-	88	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=22.5\text{V}$, $I_{\text{D}}=20\text{A}$	-	87.5	-	nC
Q_{gs}	Gate-Source Charge		-	19.3	-	
Q_{gd}	Gate-Drain Charge		-	17.3	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$	-	0.7	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=10\text{A}$, $V_{\text{R}}=22.5\text{V}$ $dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	45.1	-	nS
Q_{rr}	Reverse Recovery Charge		-	39	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

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N-Channel Typical Characteristics

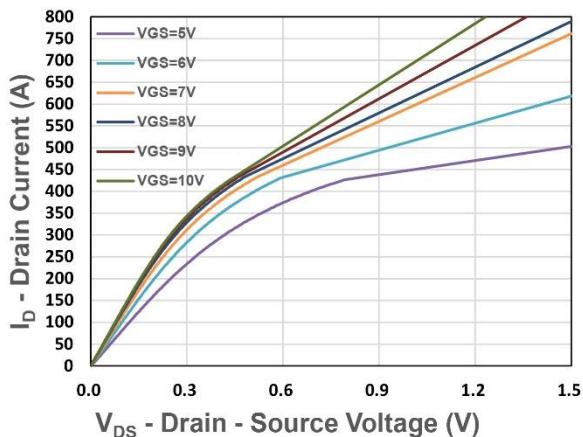


Figure 1. Output Characteristics

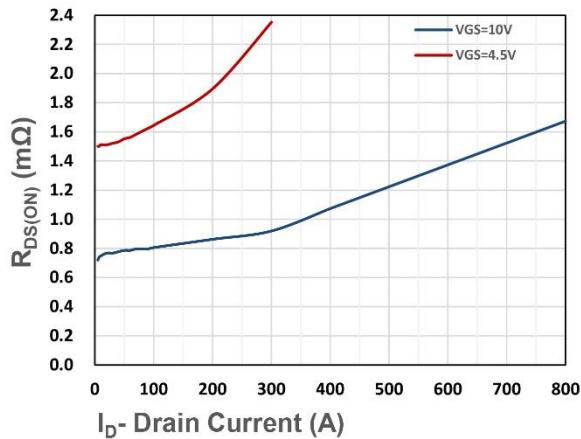


Figure 2. On-Resistance vs. ID

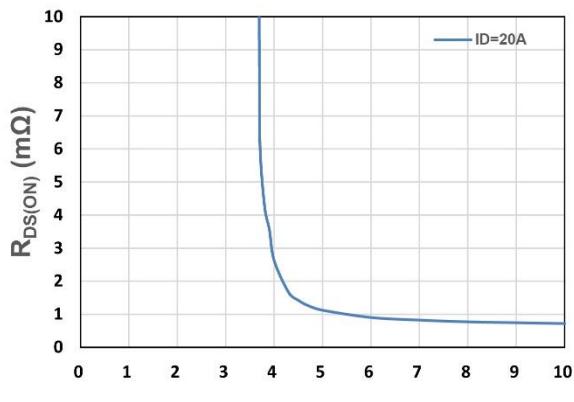


Figure 3. On-Resistance vs. VGS

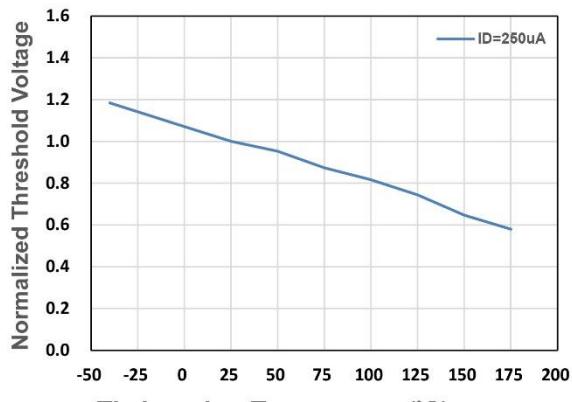


Figure 4. Gate Threshold Voltage

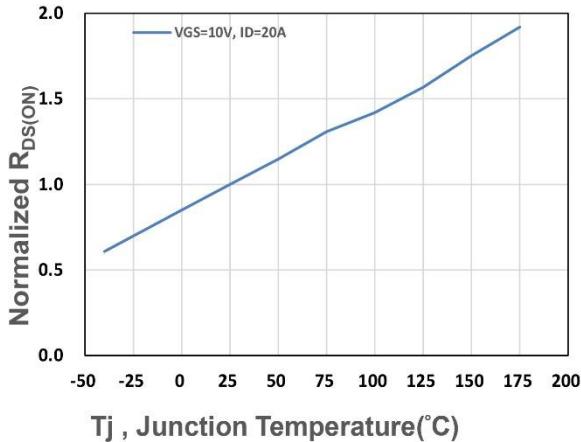


Figure 5. Drain-Source On Resistance

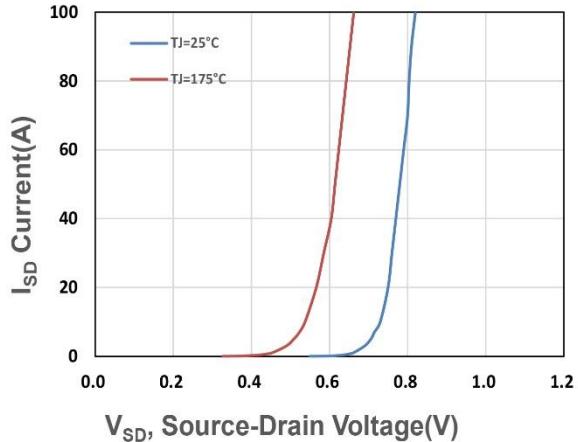


Figure 6. Source-Drain Diode Forward

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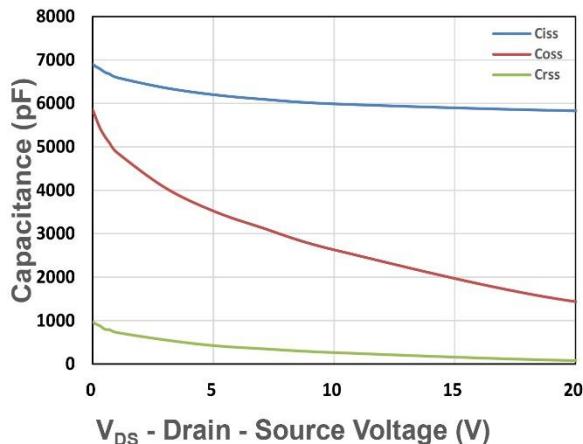


Figure 7. Capacitance

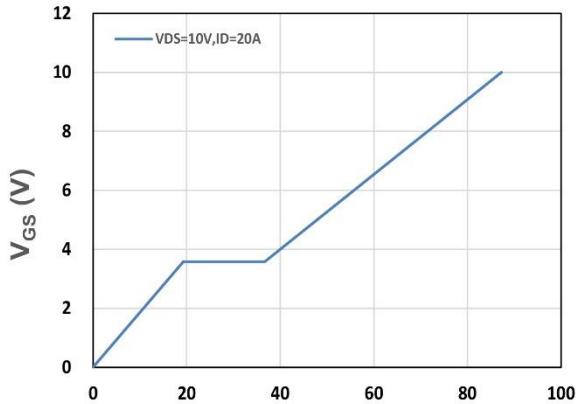


Figure 8. Gate Charge Characteristics

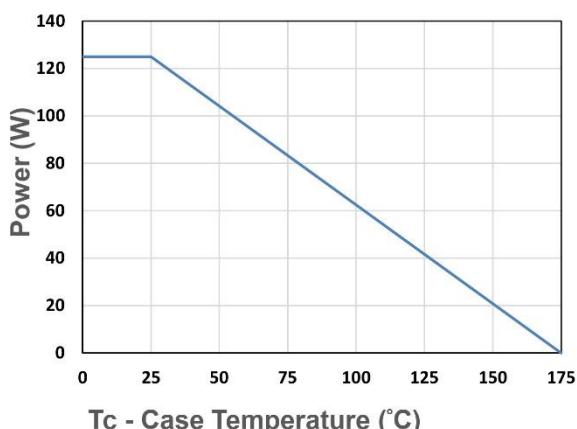


Figure 9. Power Dissipation

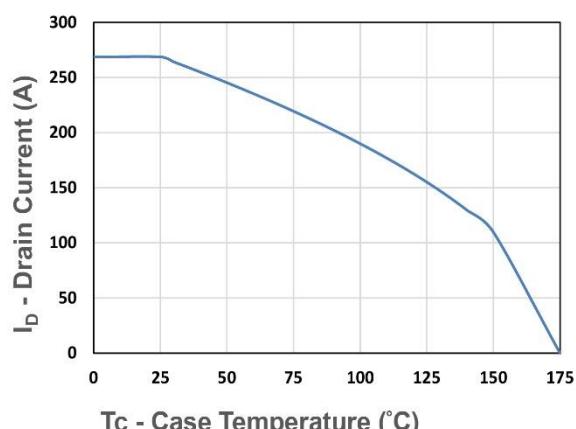


Figure 10. Drain Current

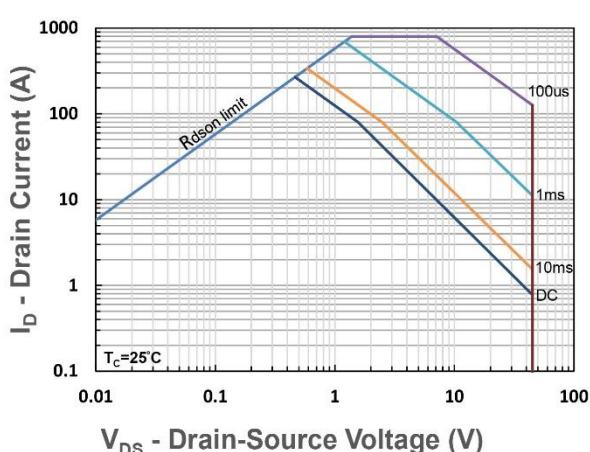


Figure 11. Safe Operating Area

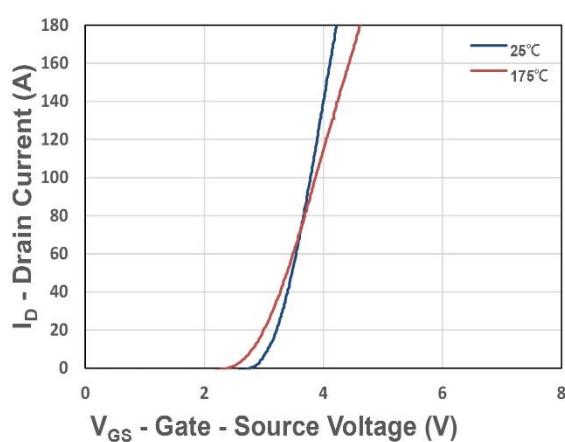


Figure 12. Transfer Characteristics

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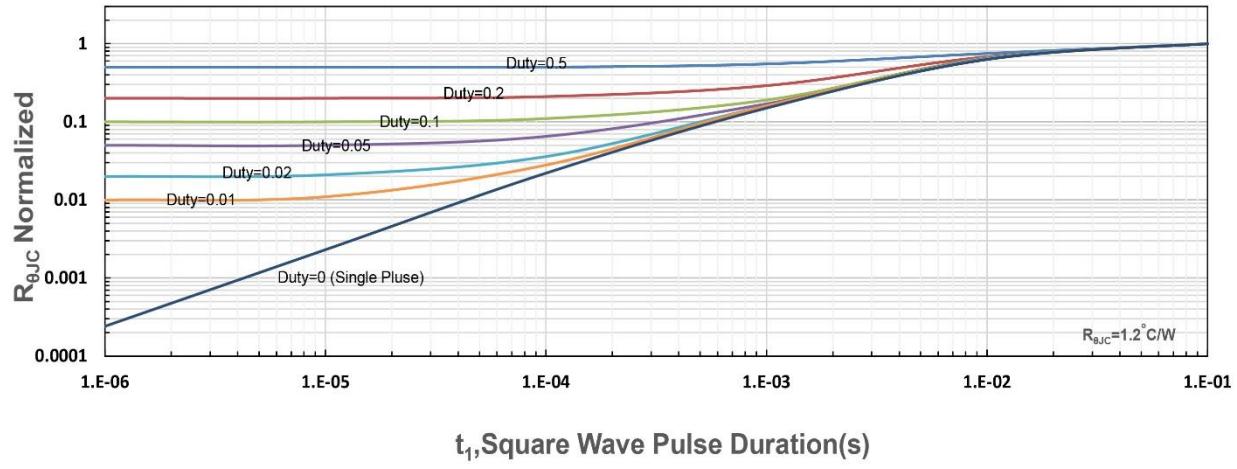


Figure 13. $R_{\theta JC}$ Transient Thermal Impedance